

Half- and Full-Duplex RS-485 Transceivers CE848XE-G Series

Features:

- Compliance Halogens Free
(Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- 5000Vrms Insulation voltage
- Logic side supply voltage (VDD1): 2.5V to 5.5V
- Bus side supply voltage (VDD2): 3V to 5.5V
- Data Rates: 12Mbps or 14Mbps
- Failsafe receiver for bus open, short, and idle
- Operation temperature: -40°C to 125°C
- Wide-body SOIC-16 package
- Pin compatible to most isolated RS-485 transceivers

Description

The CE8485E is a Half-Duplex RS-485 Transceiver, while CE8486E is a Full-Duplex RS-485 Transceiver. Both devices are certified with 5kVrms isolation voltage per UL 1577.

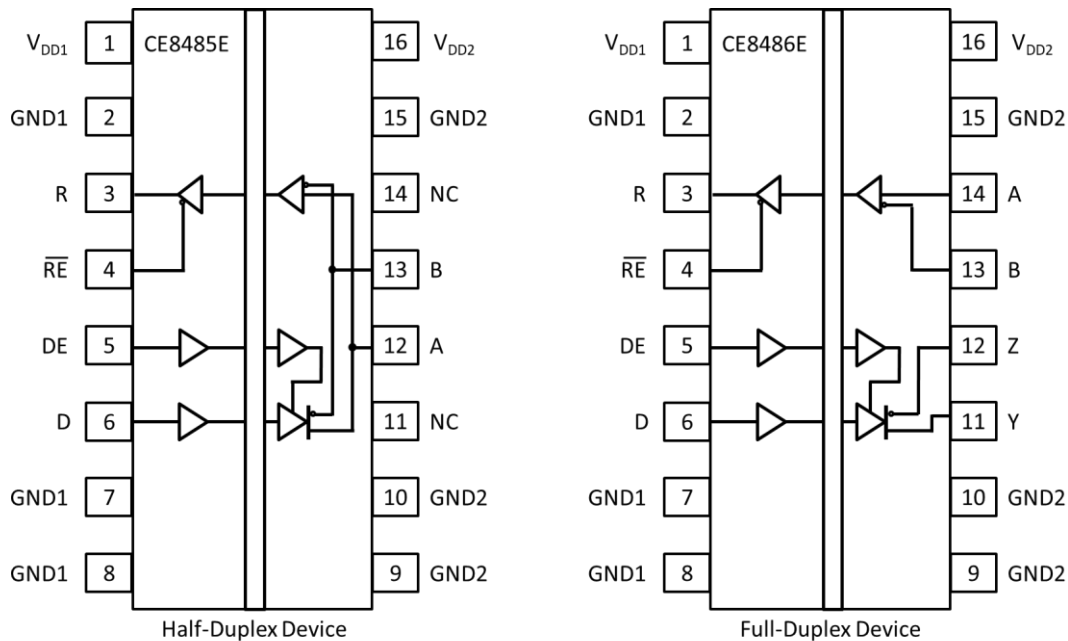
These devices are ideal for long transmission lines because the ground loop is broken to allow for a much larger common-mode voltage range.

These devices feature fail-safe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted. The devices have a 1/8-unit-load receiver input impedance that allows up to 256 transceivers on the bus.

Applications

- Isolated RS-485 Communication
- Solar inverter
- Factory automation & control
- Motor drives
- HVAC systems and building automation

Pin Description



NAME	Pin		DESCRIPTION
	CE8485E	CE8486E	
V _{DD1}	1	1	Logic side power supply
GND1	2, 7, 8	2, 7, 8	Ground for V _{DD1}
R	3	3	Receiver output
RE	4	4	Receiver enable. This pin disables the receiver output when high or open and enables the receiver output when low.
DE	5	5	Driver enable. This pin enables the driver output when high and disables the driver output when low or open.
D	6	6	Driver input
GND2	9, 10, 15	9, 10, 15	Ground for V _{DD2}
NC	11, 14	--	No Connection
Y	--	11	Receiver non-inverting input on the bus side
Z	--	12	Receiver inverting input on the bus side
A	12	--	Transceiver non-inverting input or output(I/O) on the bus side
	--	14	Driver non-inverting output
B	13	--	Transceiver inverting input or output(I/O) on the bus side
	--	13	Driver inverting output
V _{DD2}	16	16	Bus side supply voltage

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply voltage	V _{DD1}	6	V
Supply voltage	V _{DD2}	6	V
Voltage on bus pins (A, B, Y, Z w.r.t GND2)	V _{BUS}	-7~12	V
Logic voltage level (D, DE, /RE, R)	V _I	V _{DD1} +0.5 *2	V
Output current on R pin	I _O	10	mA
Isolation Voltage	V _{ISO}	5000	V rms
Operating Temperature	T _{OPR}	-40 ~ +125	°C
Storage Temperature	T _{STG}	-55 ~ +150	°C

Notes:

*1 All voltage values except differential I/O bus voltages are with respect to the local ground terminal (GND1 or GND2) and are peak voltage values.

*2 Maximum voltage must not exceed 6 V

*3 Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V _{DD1}	2.5	5.5	V
Supply Voltage	V _{DD2}	3	5.5	V
High-level input voltage (D, DE, /RE inputs)	V _{IH}	0.7×V _{DD1}	V _{DD1}	V
Low-level input voltage (D, DE, /RE inputs)	V _{IL}	0	0.3×V _{DD1}	V
Differential input voltage, A with respect to B	V _{ID}	-12	12	V
Differential input resistance	R _L	54		Ω
Output current, Driver	I _O	-60	60	mA
Output current, Receiver	I _{OR}	-8	8	mA
Signaling rate	CE8485E	1/t _{UI}	14	Mbps
	CE8486E	1/t _{UI}	12	Mbps

Electrical Characteristics: Driver

$V_{DD1} = 5V$, $V_{DD2} = 5V$, $T_A = 25^\circ C$, unless otherwise noted.

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Driver differential-output voltage magnitude	$ V_{OD} $	3		V_{DD2}	V	Open circuit voltage, unloaded bus, $3V \leq V_{DD2} \leq 5.5V$
		1.5			V	$R_L = 54\Omega$ (Fig. 1)
		1.5			V	$R_L = 100\Omega$ (RS-422) (Fig. 1)
		1.5			V	$-7V \leq V_{test} \leq 12V$ (Fig. 1)
Change in differential output voltage between two states	$\Delta V_{OD} $	-0.2	0	0.2	V	$R_L = 54\Omega$ or $R_L = 100\Omega$ (Fig. 2)
Common-mode output voltage	V_{OC}			3	V	$R_L = 54\Omega$ or $R_L = 100\Omega$ (Fig. 2)
change in steady-state common-mode output voltage between two states	$\Delta V_{OC(SS)}$		0.2		V	$R_L = 54\Omega$ or $R_L = 100\Omega$ (Fig. 2)
Short-circuit output current	I_{OS}	-200		200	mA	V_A or $V_B = -7V$, Other input at 0 V V_A or $V_B = 12V$, Other input at 0 V
Input current	I_i	-10		10	μA	V_D and $V_{DE} = 0V$ or V_D and $V_{DE} = V_{DD1}$
Common-mode transient immunity	CMTI		100		kV/ μs	Fig.8

Electrical Characteristics: Receiver

$V_{DD1} = 5V$, $V_{DD2} = 5V$, $T_A = 25^\circ C$, unless otherwise noted.

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Receiver differential threshold voltage	V_{TH}		-100		mV	
Hysteresis voltage	V_{hys}		30		mV	
Output high voltage on the R pin	V_{OH}	$V_{DD1}-0.4$			V	$V_{ID} = 200mV$, $I_o = -4mA$
Output Low voltage on the R pin	V_{OL}			0.4	V	$V_{ID} = -200mV$, $I_o = 4mA$
Output high-impedance current on the R pin	$I_{O(Z)}$	-1		1	μA	$V_R = 0V$ or $V_R = V_{DD1}$, $V_{RE} = V_{DD1}$
Bus input current	I_{i1}		0.04	0.1	mA	V_A or $V_B = 12V$, Other input at 0V
			0.06	0.13	mA	V_A or $V_B = 12V$, $V_{DD} = 0$, Other input at 0V
		-0.1	-0.04		mA	V_A or $V_B = -7V$, Other input at 0V
		-0.05	-0.03		mA	V_A or $V_B = -7V$, $V_{DD} = 0$, Other input at 0V
Input Current on the RE pin	I_i	-10		10	μA	$V_{RE} = 0V$ or $V_{RE} = V_{DD1}$

Differential input resistance	R_{ID}	96		k Ω	A, B
Common-mode transient immunity	CMTI		100	kV/ μ s	Fig.8

Supply Current

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Logic-side supply current	I_{DD1}			3.2	mA	$V_{RE} = 0\text{ V}$ or V_{DD1} , $DE = 0\text{ V}$ or V_{DD1} ($V_{DD1}=3.3\text{V}$)
				3.3	mA	$V_{RE} = 0\text{ V}$ or V_{DD1} , $DE = 0\text{ V}$ or V_{DD1} ($V_{DD1}=5\text{V}$)
Bus-side supply current	I_{DD2}			4.4	mA	$V_{RE} = 0\text{ V}$ or V_{DD1} , $DE = 0\text{ V}$, No load

Switching Characteristics: Driver

$V_{DD1} = 5\text{V}$, $V_{DD2} = 5\text{V}$, $T_A=25^\circ\text{C}$, unless otherwise noted.

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Propagation delay	t_{PLH} , t_{PHL}		65		ns	
Pulse skew ($ t_{PHL} - t_{PLH} $)	PWD		3		ns	Fig.3
Differential output signal rise and fall time	t_r , t_f		12		ns	
Enable time	t_{PZH}		65		ns	Fig.4
\Enable time	t_{PZL}		65		ns	Fig.5
Disable time	t_{PHZ}		65		ns	Fig.4
Disable time	t_{PLZ}		65		ns	Fig.5

Switching Characteristics: Receiver

$V_{DD1} = 5\text{V}$, $V_{DD2} = 5\text{V}$, $T_A=25^\circ\text{C}$, unless otherwise noted.

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Propagation delay	t_{PLH} , t_{PHL}		80		ns	Fig.6
Pulse skew ($ t_{PHL} - t_{PLH} $)	PWD		10		ns	Fig.6
Differential output signal rise and fall time	t_r , t_f		1		ns	Fig.6
Enable time	t_{PZH}		45		ns	Fig. 7
Enable time	t_{PZL}		45		ns	Fig. 7
Disable time	t_{PHZ}		60		ns	Fig. 7
Disable time	t_{PLZ}		45		ns	Fig. 7

Fig.1 Driver Voltages

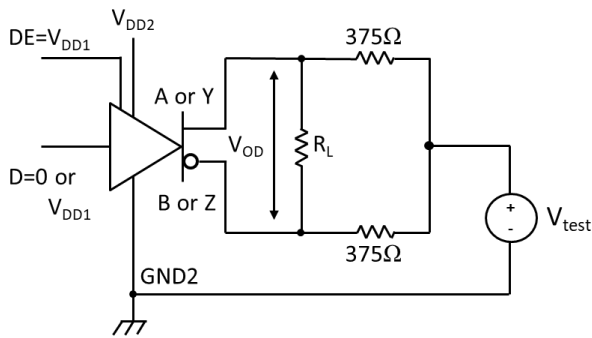
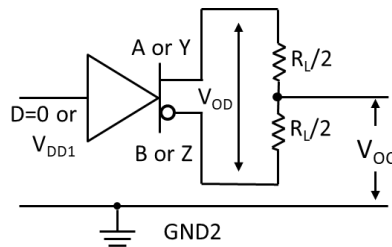
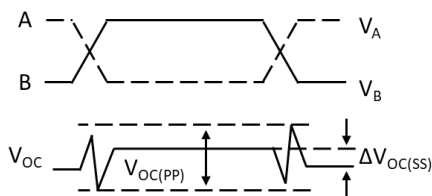
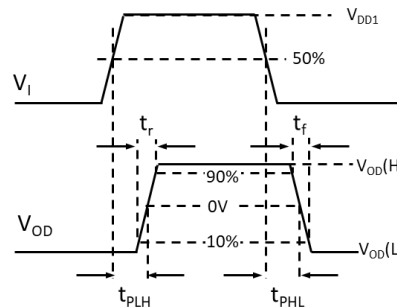
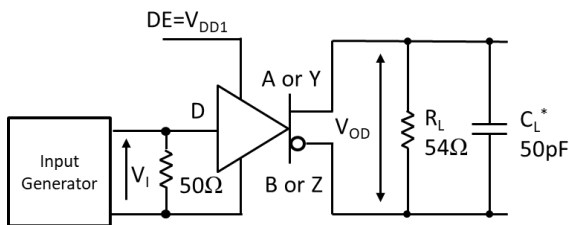


Fig.2 Driver Voltages



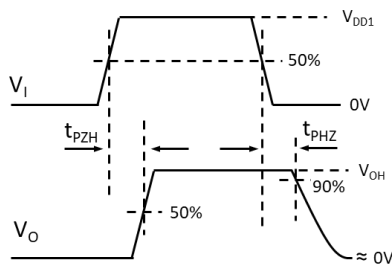
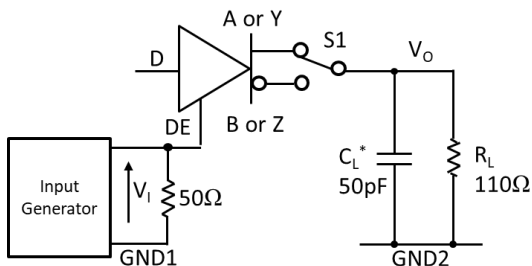
$R_L = 100\Omega$ for RS422, $R_L = 54\Omega$ for RS-485

Fig.3 Driver Switching Specifications



C_L includes fixture and instrumentation capacitance.

Fig.4 Driver Enable and Disable Times



C_L includes fixture and instrumentation capacitance.

Fig.5 Driver Enable and Disable Times

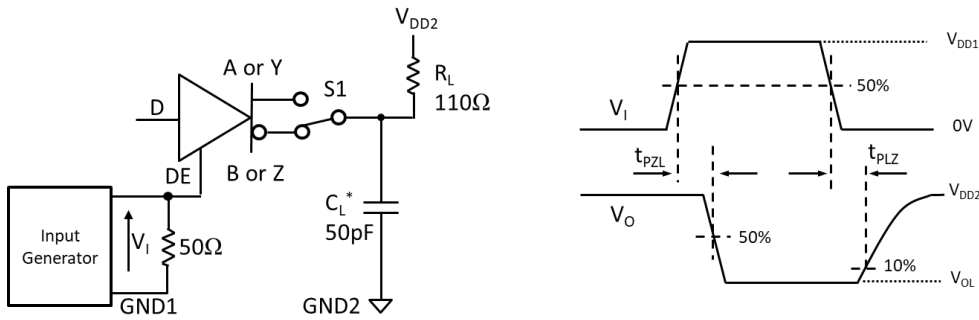


Fig.6 Receiver Switching Specifications

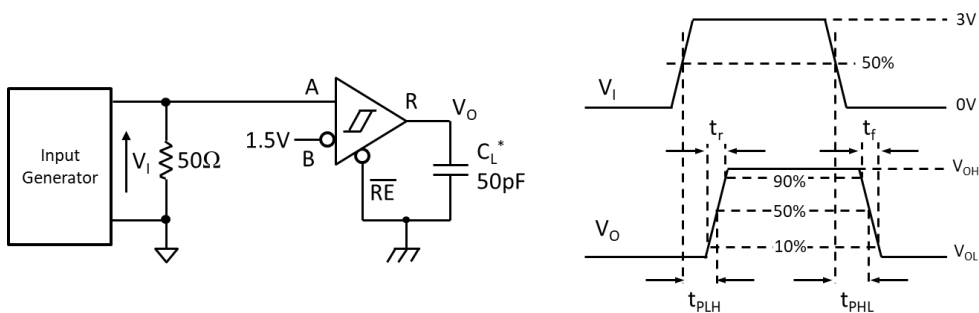


Figure 7. Receiver Enable and Disable Times

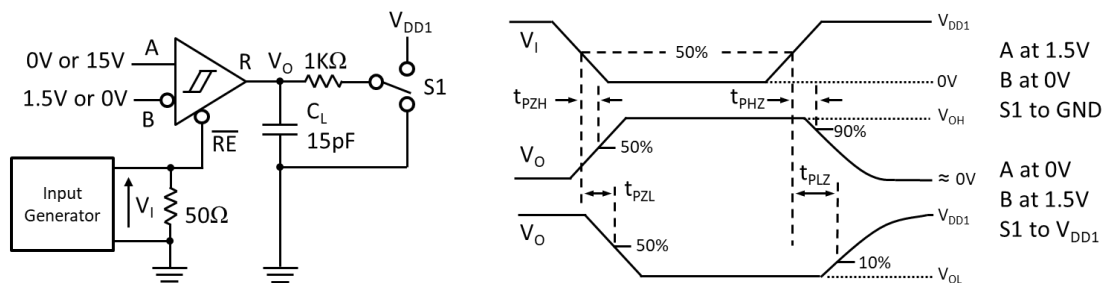
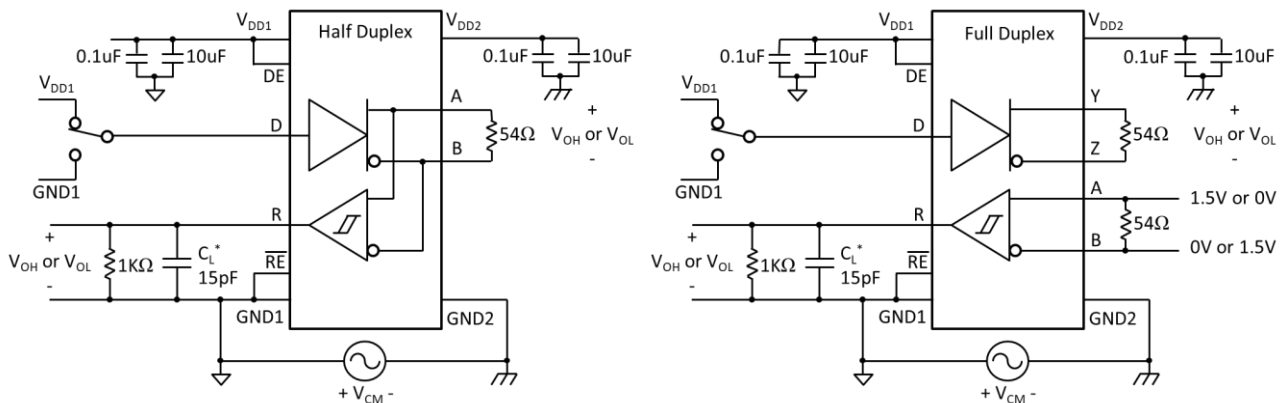


Figure 8. Common Mode Transient Immunity (CMTI)—Half Duplex and Full Duplex



C_L includes fixture and instrumentation capacitance.

Order Information

Part Number

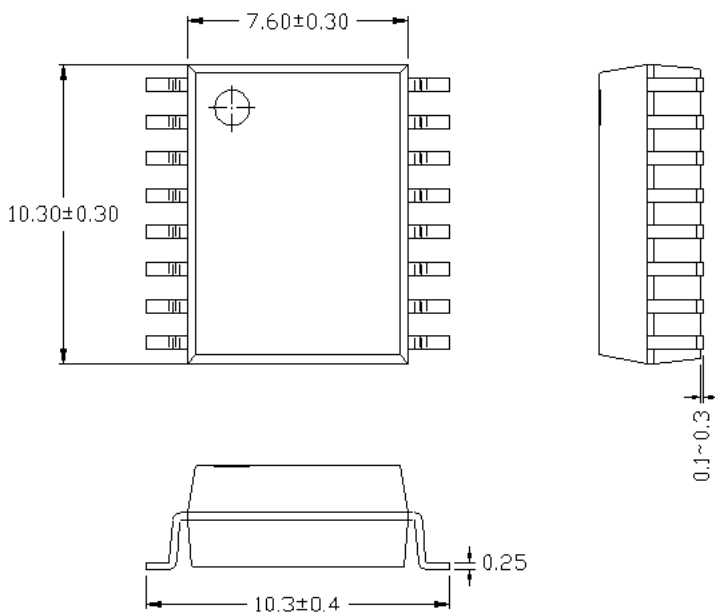
CE8485E(TA)-G
CE8486E(TA)-G

Note

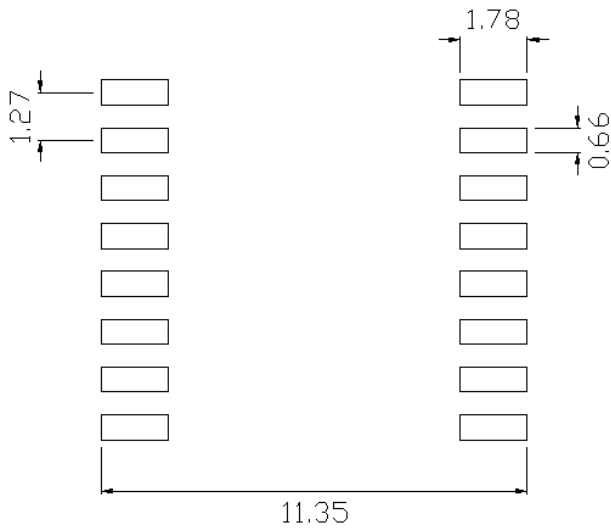
CE = denotes EVERLIGHT
 8485E = part no.
 8486E
 G = Halogens free

Option	Description	Packing quantity
(TA)	Surface mount lead form + TA tape & reel option	1500 units per reel

Package Dimension
 (Dimensions in mm)



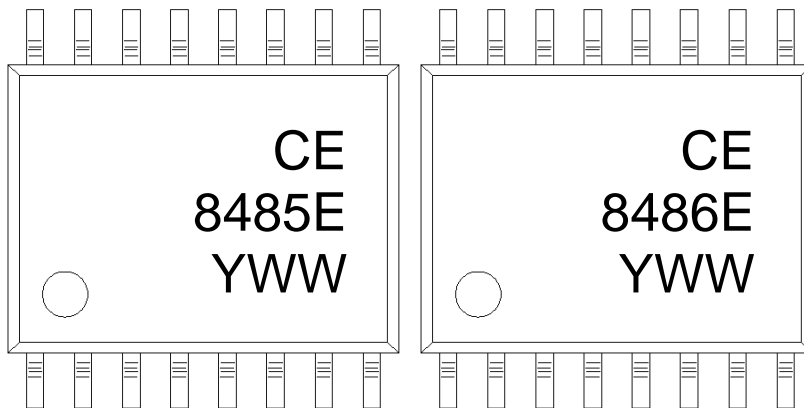
Recommended pad layout for surface mount leadform



Notes.

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Device Marking



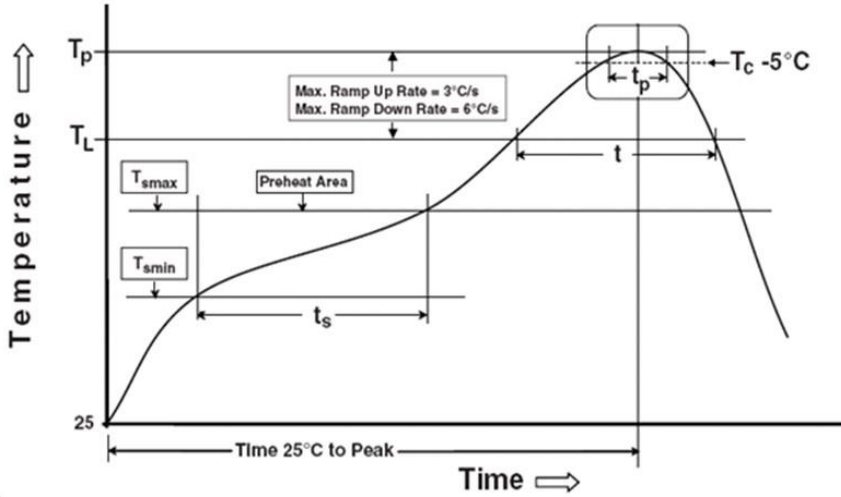
Notes

CE denotes EVERLIGHT
8485E denotes Device Number
8486E
Y denotes 1 digit Year code
WW denotes 2 digit Week code

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_p)	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

DISCLAIMER

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
4. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without the specific consent of EVERLIGHT.
5. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.
6. Statements regarding the suitability of products for certain types of applications are based on Everlight's knowledge of typical requirements that are often placed on Everlight products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Everlight's terms and conditions of purchase, including but not limited to the warranty expressed therein.